1.0 OBJECTIVE

This specification defines the performance, test, quality and reliability requirements of the modular metric Metral[®] B receptacles connector.

2.0 <u>SCOPE</u>

This specification is applicable to the termination characteristics of the Metral[®] B receptacle family of products which provides a separable interconnect for printed circuit boards, and includes press-fit & solder to board receptacle connector.

3.0 GENERAL

This document is composed of the following sections:

Paragraph	Title
1.0 2.0 3.0 4.0	OBJECTIVE SCOPE GENERAL APPLICABLE DOCUMENTS
4.0 5.0	REQUIREMENTS
5.1	Qualification
5.2	Definitions
5.3	Material
5.4	Finish
5.5	Design and Construction
6.0	TEST METHODS AND REQUIREMENTS
6.1	ELECTRICAL CHARACTERISTICS
6.2	MECHANICAL CHARACTERISTICS
6.3	ENVIRONMENTAL CONDITIONS
7.0	QUALITY ASSURANCE PROVISIONS
7.1	Equipment Calibration
7.2	Inspection Conditions
7.3	Sample Quantity and Description
7.4	Acceptance
7.5	Qualification Testing
7.6	Requalification Testing
TABLE 1	QUALIFICATION TEST SEQUENCE MATRIX
8.0	RECORD RETENTION

4.0 APPLICABLE DOCUMENTS

The following documents, of the issue in effect on the date of the latest revision of this specification, shall form a part of this specification to the extent specified herein.

- **4.1** Scope: This product line performance is defined in several external industry standards as identified in this section. Only performance standards exceeding or not defined in these external standards will be covered in this document
- **4.2** Industry Product Performance Standards

IEC 512: Electromechanical components for electronic equipment, basic testing procedures and measuring.

IEC 707: Method of test for the determination of the flammability of solid electronic insulating material exposed to an igniting source

EIA-IS64: 2mm two-part connector for printed wiring boards and backplanes

EIC-364-04: Normal Force test procedure for electrical connectors

Bell core GR-1217-CORE: Generic Requirements for Separable Electrical Connectors Used in Telecommunications Hardware.

- 4.3 AFCI Specifications:
 - (a) General requirements from test specifications
 - (b) Engineer Drawings
 - (c) Process Drawings
 - (d) GS-20-001/ BUS-20-059 Heat stake Application Specification

(e) BUS-03-108 Crosstalk

(f) BUS-03-110 Characteristic Impedance

- (g) BUS-03-111 Propagation Delay
- (h) BUS-03-113 Inductance
- (i) BUS-03-114 Capacitance
- (j) BUS-20-059 Application Specification
- (k) GS-15-002 NXT[™] Electrodeposited Amorphous Nickel With Gold Overplate
- (I) GS-15-011 GXT® & GXT+™ Electrodeposited Deposited Palladium-Nickel Alloy With Gold Overplate
- 4.4 Military Specifications
- 4.5 Military Standards:
 - (a) MIL-STD-202F: Test methods for electrical and electronic components
 (b) MIL-STD-1344A: Test methods for electrical connectors.
 (c) MIL-G-45204: Gold Plating (electro-deposited)
 (d) MIL-P-81728: SnPb Plating
- 4.6 U.S. Federal Specifications
 - (a) QQ-N-290: Nickel Plating (electro-deposited)
 - (b) UL-STD-498: Standard for attachment plugs and receptacles
 - (c) UL-STD-94: Test for flammability of plastic materials

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5.0 REQUIREMENTS

5.1 Qualification U.S. Federal Specifications

Connectors furnished under this specification shall be capable of meeting the qualification test requirements specified herein.

5.2 Definitions:

- 5.2.1 Receptacle Signal Contact Solder to Board A dual beam female right angle contacts with a solder tail for termination to the printed circuit board
- 5.2.2 Receptacle Power Contact Solder to Board A dual beam female right angle contacts with a solder tail for termination to the printed circuit board
- 5.2.3 Receptacle Insulator Housing The plastic modules in which the female contacts are retained
- 5.3 Material: the material for each parts shall be specified herein
 - 5.3.1 Metallic Parts: Receptacle Contact Body: The receptacle shall be phosphor bronze alloy CuSn6 or SuSn5.
 - 5.3.1 Insulator Parts:

All receptacle housing material shall be liquid Crystal Polymer 30% glass standard IEC 707, category FV-1

5.4 Finish

Contact Area:

The finish for applicable components shall be as specified herein or equivalent. Reference BUS-02-057. The receptacle terminals shall be plated with 30u" minimum thickness of either gold or GXT[™] over 50u" minimum thickness nickel under plate .The gold deposit shall meet the requirements of MIL-G-45204, type II, Grade C and the nickel deposit shall meet the requirements of QQ-N-290, class 2.Connectors shall be of the design, construction, and physical dimensions specified on the applicable product drawing. The intended application of product to a PCB is via compliant methods

CONTACT PLATING:

2.0 Micron gold / 1.3 micron min. Nickel 1.3 Micron gold / 1.3 micron min. Nickel 0.8 Micron gold / 1.3 micron min. Nickel 0.8 Micron GXT / 1.3 micron min. Nickel

Solder Tail Area: Tin/Lead plating or Matte Tin plating with Nickel under-plated.

5.5 Design and Construction:

The receptacle connector shall be a multi –piece assembly having 4(or 5) rows of contacts with solder tail terminations for installation in 1.48mm to 2.57mm thick printed circuit boards. The receptacle contacts shall interface with a 0.5mm male pin on a 4 or 5 row 2mm grid.

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5.5.1 Mating:

The receptacle connectors shall be capable of mating with any appropriately constituted male connector of the same population without any degradation in performance.

5.5.2 Workmanship:

Connectors shall be uniform in quality and shall be free from burrs, scratches, cracks, voids, chips, blisters, pin holes, sharp edge, and other defects that will adversely effects life or serviceability.

6.0 TEST METHODS AND REQUIREMENTS

Unless otherwise specified, all inspections shall be performed under the following ambient

- Temperature ----- 20°C ~ 30°C
- Humidity ----- 30% ~ 60%
- Pressure ----- Local Ambient

6.1 ELECTRICAL CHARACTERISTICS

ltem	Test Description		Requirements	Test Methods
6.1.1	Visual Examination	Product shall meet the requirements of product drawings. Visual Examination performed under 10X magnification. Parts should be free from blistering, discoloration, cracks, etc		EIA-364-18B <u>Visually and functionally</u> inspected. Under 10X magnification.
6.1.2	LL Contact Resistance	Signal Row A Row B Row C Row D Row E Power All Row Shorting contact	Initial Resistance (Milliohms Maximum) 25 mΩ 35 mΩ 40 mΩ 45 mΩ 45 mΩ After test : $\Delta R \le 10 m\Omega$ 10 mΩ 30 mΩ After all mechanical and environmental tests	SEE EIA-304-23C a) <u>Test Voltage-20 mV</u> <u>DC max open circuit</u> <u>voltage.</u> b) <u>Test Current – Not to</u> <u>exceed 100 mA.</u> SEE EIA-IS-64_for contact resistance measurement points.
	Current	Signal Pin	1.5 A The current carrying capacity of a mated signal pair is rated at 1.5 ampere with current applied to all contacts [24 (4 row) or 30(5 row) contacts]	SEE EIA-364-70 <u>Ambient still air is 25°C</u>
6.1.3	Carrying Capacity	Power Pin	3.0 A The current carrying capacity of a mated power pair is rated at 3 ampere with current applied to all contacts [24 (4 row) or 30(5 row) contacts]	SEE EIA-364-70 <u>Ambient still air is 25°C</u>

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Measured in accordance with EIA 364-21.The following details shall apply: a.Test Voltage - 500 volts DC $5 x 10^3 \ M\Omega$ Insulation Initially: b. Electrification Time - 1 6.1.4 $1 \times 10^3 M\Omega$ After Tests : Resistance minute c. Points of Measurement -Between adjacent contacts and between contacts and metal shields Accordance with EIA 364-20. The following details shall apply: a. Test Voltage - 1000 VDC, 60Hz. Dielectric There shall be no evidence of arc-over, insulation b. Test Duration - 60 seconds. 6.1.5 Withstanding breakdown, or excessive leakage current (> 0.5 milliampere) c. Voltage: Applied at a rate of Voltage 1000 volts per second. d. Points of Measurement -Between adjacent contacts and between contacts and the metal shields The following details apply per BUS-03-114 a) Connectors shall be mated and mounted onto test boards. The capacitive coupling between adjacent rows of b) Test condition: 1 MHz at 1 contacts shall not exceed 3pF. 6.1.6 Capacitance nsec rise time. The capacitive coupling between adjacent contacts c) Measurement equipment: within a row shall not exceed 2pF. Impedance analyzer or other suitable equipment capable of measuring capacitance at 1 MHz. The following details apply per BUS-03-113. a) Connectors shall be mated. b) Measurements shall be made from tail tip to tail tip. The inductance between adjacent contacts shall be c) Test conditions 1 ns rise no greater than 25nH, and between one contact and 6.1.7 Inductance time pulse (0.0 V to 1.0 V), all other surrounding contacts grounded shall be no with a 50 Ohm termination. greater than 15nH. d) Measurements equipment : Sampler/TDR/Scope equipment with a 50 Ohm reference impedance. The following details apply per The maximum propagation delay shall not exceed 225 Propagation BUS-03-111 6.1.8 psec, and the maximum row-to-row delay shall not Delay a) Connector shall be mated. exceed 40 psec b) Measurements shall be made from tail tip to tail tip

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			c) Test Condition: 250 psec rise time pulse (0.0 V and 2 V) with a 50 Ohm termination. d) Measurements equipment: Sampler/pulse generator/scope equipment with a 50 Ohm reference impedance and 250 psec rise time
6.1.9	Cross Talk	Adjacent active/quiet near end cross talk shall not exceed 5% in any row or column combination. The far end cross talk shall nt exceed 2.5%.	The following details apply per BUS-03-108 <u>a) Connectors shall be mated.</u> <u>b) Measurements shall be</u> <u>made from tail tip to tail tip.</u> <u>c) Test Condition: 1 ns rise</u> <u>time pulse (0.0 V to 2.0 V) with</u> <u>a 50 Ohm termination.</u> <u>d) Measurements equipment:</u> <u>Sampler/Pulse</u> <u>Generator/Scope equipment</u> <u>with 50 Ohm</u> <u>reference impedance.</u>
6.1.10	Characteristics Impedance	The mated connector characteristic impedance shall be within the range of 50-60 Ohms.	The following conditions apply per BUS-03-110 <u>a) Sample documentation;</u> <u>b) Sample test conditions.</u>

6.2 MECHANICAL CHARACTERISTICS

Item	Test Description		Requirements	Test Methods
		Contact Type	Axial Force (Minimum)	Measured in accordance with EIA-364-29.
6.2.1	Contact Retention to Housing	Receptacle	5 Newton <u>There shall be no loosening of the</u> <u>contact or damage to the contact or</u> <u>damage to the connector</u>	A force is applied to a contact in either direction along the axis of retention
		Contact Type	Mating/Unmating Force/ Per Contact	Reference – IEC 60512-13-2 or EIA- 364-13.
6.2.2	Total Mating /Unmating Force	Signal	≤0.45 Newton/Per Contact ≥0.15 Newton/Per Contact <u>The total force to mate a female</u> <u>connector with an appropriately</u> <u>populated male header shall not</u> <u>exceed the above values times the</u> <u>number of contacts.</u>	a. Cross Head Speed 25.4 mm per minute. b. Lubrication – No c. Utilize free floating fixtures.
		Power	≤1.5 Newton/Per Contact ≥0.30 Newton/Per Contact <u>The total force to mate a female</u> <u>connector with an appropriately</u> <u>populated male header shall not</u>	

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			exceed the above values times the	
			number of contacts.	
		Signal	The individual insertion force shall not exceed 0.45 Newton	Measured in accordance with EIA-364-37
	Individual			Using a maximum gage (configuration as shown in EIA-
6.2.3	Contact Insertion Force	Power	The individual insertion force shall not exceed 1.5 Newton	<u>(Configuration as shown in EIA-</u> <u>IS-64).</u>
			The individual withdrawal force	Measured in accordance with
	Individual	Signal	shall be no less than 0.15 Newton	EIA-364-37 After 5 insertions of a maximum
6.2.4	Contact Withdrawal Force	Power	The individual withdrawal force shall be no less than 0.30 Newton	gage, the force required to withdraw a minimum gage (configuration as shown in EIA- IS-64)
			prce for receptacle contacts only shall	Measured in accordance with
6.2.5	Normal Force	be no less than the below data after life test.		EIA-364-04.
0.2.0		Signal Power	0.4 Newton Minimum 0.8 Newton Minimum	
	Press Peg Insertion/ Retention Force	Insertion force	The Insertion force shall not exceed 32 Newton.	Insert a single press peg into a plated through hole in a printed circuit board at a rate of 5.1 mm/minute.
6.2.6	Press Peg	Retention force	The retention force in an axial direction opposite that of insertion shall not be less than 7 Newton.	Push out at a rate of 1.0mm/minute.
6.2.7	Compliant Pin Insertion	Complian Pin Insertion/Retention Force The force required to insert header with compliant pins into plated through holes in a printed circuit board at a rate of 0.5 inches/minute shall not exceed 65 N per pin.		Per EIA-364-5 <u>Measure force necessary to</u> <u>correctly apply a specimen to a</u> <u>printed circuit board at a</u> <u>maximum rate of 12.7mm per</u> <u>minute.</u>

6.2.8	PCB Hole Deformation Radius	shall be no great from the finishe	aximum deformation radius shall	Reference Telcordia GR-1217- CORE, section 5.1.7. Cross-section should be parallel to board surface. Photograph and measure the holes deformation radius at a point 0.25mm from the surface and at the center of the compliant pin section.
6.2.9	Compliant Pin Retention	that of insertion	orce in an axial direction opposite n shall not be less than 20 N per rtion/extraction cycles on the	Per EIA-364-5 <u>Measure force necessary to</u> <u>correctly apply a specimen to a</u> <u>printed circuit board at a</u> <u>maximum rate of 12.7mm per</u> <u>minute.</u>
6.2.10	Durability		durance (number of mate/unmate nector class shall be the below CONDITIONS 250 CYCLES MINIMUM 100 CYCLES MINIMUM 30 CYCLES MINIMUM	Standard laboratory procedure as applicable to the specific product EIA-364-09 Cycling Rate - 5 inches per minute
		CLASS CLASS I	CONDITIONS 10 TO 2000 Hz AND 1,5 mm or 20g	Accordance with Telcordia GR- 1217-CORE, November 1995 <u>a. Vibration Amplitude - 0.06" DA</u> <u>or 10G acceleration</u> <u>b. Frequency Range - 10 to 500</u>
6.2.11	Vibration	CLASS II	10 TO 500 Hz AND 0,35 mm or 5g	hertz c. Duration - 8 hours along each of three orthogonal axes (24 hours total)
		CLASS III	N/A	<u>d. Mounting - Rigidly mount</u> <u>assemblies</u> <u>e. No discontinuities greater than</u> <u>1u second</u>

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6.2.12	Mechanical Shock	No Damage	Accordance with Telcordia GR- 1217-CORE, November 1995 sections 6.3.5 and 9.1.2.1. <u>a. Conditions - half-sine 30G, 11</u> <u>millisecond duration</u> <u>b. Shocks - 3 shocks along each</u> <u>of three orthogonal axes</u> <u>c. Mounting - Rigidly mount</u>
			assemblies
			d. Resistance measurements taken after shock in each axis.

6.3 ENVIRONMENTAL CONDITIONS

ltem	Test Description	Requirements	Test Methods
			Measured in accordance with EIA 364-32A November 183, Test Condition II
6.3.1	Thermal Shock	No Damage	a. Number of Cycles - 5 b. Temperature Range - Between -55 °C +0°C/-5°C and +85° C +3°C/-5°C c. Time at Each Temperature - 30 minutes d. Transfer Time - 5 minutes, maximum
6.3.2	Humidity	No Damage	Mated samples are to be exposed to cyclical humidity and temperature in accordance with EIA-364-TP31, Method IV, with the following exceptions. Samples are to be subjected to 50 cycles of 10 hours duration for a total of 500 hours after 24 hours in a conditioning oven at 50+/- 2°C. A cycle consists of the following steps: <u>1.) Ramp from 25+/-2°C at 80%- 98% RH to 65+/-2°C at 94%+/-</u>
			<u>4% RH in 120 minutes</u> <u>2.) Dwell at 65+/-2°C at 94%+/-</u> <u>4% RH for 4 hours</u>

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			3.) Ramp down to 25+/-2°C at 80%-98% RH in 120 minutes 4.) Dwell at 25+/-2°C at 80%- 98% RH for 2 hours
6.3.3	High Temperature Life	No Damage	Telcordia GR-1217-CORE Method A, Test Condition 3. Headers and receptacles shall be mated w/o any electrical load <u>a. Test Temperature - 85 degree</u> <u>C +/- 2 degree C</u> <u>b. Test Duration - 500 hours</u>
	Mixed Flow Gas	No Damage	Samples are to be exposed to industrial gas mixture in accordance with Telcordia GR- 1217-CORE, November 1995, Section 9.1.3. The headers only
6.3.4	8.4.1 <u>U</u>	Central OfficeConstituentGas ConcentrationNO2200 ppbCL210 ppbH2S10 ppbSO2100 ppbGas concentrations per Central Officencontrolled EnvironmentConstituentGas ConcentrationNO2200 ppbCL220 ppbH2S100 ppbSO2200 ppbGas concentrations per Uncontrolled Environment	are to be exposed for 10 days to the gas mixture detailed below, with interim resistance measurements made after the 5th and 10th days. The samples are then mated with the appropriate receptacle and exposed to an additional 10 days with resistance measurements taken after the 15th and 20th days of exposure. The test chamber is to be maintained at a temperature of 30°C+/-1°C with a relative humidity of 70%+/-2%. Specific please see right table
6.3.5	Resistance to Solder Heat	Shall meet visual requirements, show no physical damage,	Place the connector on the PCB and expose to the reflow oven. Peak Temp: 260 for 10sec.
6.3.6	Dust Contamination	No Damage	EIA-364-91A <u>Unmated to dust composition #1</u> for 1 hours

Salt Spray Acceptance criteria – (visual examination requirements and/or LLCR criteria) EIA-364-26 a. Test Condition :B b. Duration : 48	Solderability (Non Eye of the Needle)	Minimum solder coverage: 95 %	037 <u>a. Test Condition A1 (ANSI-J-</u> STD-002)
Salt Spray Acceptance criteria – (visual examination <u>a. Test Condition :B</u>			
	Salt Spray		a. Test Condition :B

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7.0 QUALITY ASSURANCE PROVISIONS.

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6.3.7

6.3.8

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7.1 Equipment Calibration

All test equipment and inspection facilities used in the performance of any test shall be maintained in a calibration system in accordance with MIL-C-45662 and ISO 9000.

7.2 Inspection Conditions

Unless otherwise specified herein, all inspections shall be performed under the following ambient conditions:

- a. Temperature: 25 +/- 5 degree C
- b. Relative Humidity: 30% to 60%
- c. Barometric Pressure: Local ambient

7.3 Sample Quantity And Description

Sample quantity for each Test Group in Table 1 shall consist of a minimum of one hundred (100) contacts. The 100 contacts shall be selected from a minimum of four (4) connectors.

7.4 Acceptance

- 7.4.1 Electrical and mechanical requirements placed on test samples as indicated in paragraphs 6.1 and 6.2 shall be established from test data using appropriate statistical techniques or shall otherwise be customer specified, and all samples tested in accordance with this product specification shall meet the stated requirements.
- 7.4.2 Failures attributed to equipment, test setup, or operator error shall not disqualify the product. If product failure occurs, corrective action shall be taken and samples resubmitted for qualification.

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7.5 Qualification Testing

Qualification testing shall be performed on sample units produced with equipment and procedures normally used in production. The test sequence shall be as specified in EIA-IS64.

7.6 Requalification Testing

If any of the following conditions occur, the responsible product engineer shall initiate requalification testing consisting of all applicable parts of the Test Schedule Tables in EIA-IS64.

a. A significant design change is made to the existing product, which impacts the product form, fit or function. Examples of significant changes shall include, but not be limited to, changes in the plating material composition or thickness, contact force, contact surface geometry, insulator design, contact base material, or contact lubrication requirements.

b. A significant change is made to the manufacturing process, which impacts the product form, fit or function.

c. A significant event occurs during production or end use requiring corrective action to be taken relative to the product design or manufacturing process.

7.7 Qualification Test Table

7.7.1 Test Table-1 (This table applies to head pins are eye of the needle type)

					Test C	Group)						
		1	2	3	4	5	6	7	8	9	10	11	
Test	Para.				Test Se	quen	се						
Visual Examination	6.1.1	1,13	1,11	1,5	1,11	1,8	1,5	1,5	1,3	1.3	1,4	1,4	
Low Level Contact Resistance Signal contacts	6.1.2	2,4,6,8,10,12	2,4,6,8,10	2,4	2,4,6,8,10		2,4						
Low Level Contact Resistance Power contacts	6.1.2	2,4,6,8,10,12	2,4,6,8,10	2,4	2,4,6,8,10		2,4						
Current Carrying Capacity (Temperature rise vs current)	6.1.3								2				
Insulation Resistance	6.1.4					2,7							
Dielectric Withstanding Voltage	6.1.5					3,6							
Vibration	6.2.1 1	9											
Mechanical Shock	6.2.1 2	11											
Durability	6.2.1 0	4	5		3,9								
Mating/Unmating Force	6.2.2	3,5											

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Contact Retention to Housing	6.2.1									3		
Press Peg Insertion/Retention Force	6.2.6								2			
Compliant pin insertion	6.2.7							2			2	
Radial hole distortion	6.2.8										3	
Compliant pin retention	6.2.9							4				
Thermal Shock	6.3.1		3			4						
Humidity	6.3.2		9			5						
High Temperature Life	6.3.3			3				3		2		
MFG (10 Days Unmated)	6.3.4				5							
MFG (10 Days Mated)	6.3.4				7							
Salt Spray	6.3.8						3					
Dust Contamination	6.3.6	7	7									

7.7.2

Test Table-2 (This table applies to head pins are non eye of the needle type)

					Test Gro	oup						
		1	2	3	4	5	6	7	8	9	10	
Test	Para.				Test Sequ	ence						
Visual Examination	6.1.1	1,13	1,11	1,5	1,11	1,8	1,5	1,4	1,3	1.3	1,4	
Low Level Contact Resistance Signal contacts	6.1.2	2,4,6,8,10,12	2,4,6,8,10	2,4	2,4,6,8,10		2,4					
Low Level Contact Resistance Power contacts	6.1.2	2,4,6,8,10,12	2,4,6,8,10	2,4	2,4,6,8,10		2,4					
Current Carrying Capacity (Temperature rise vs current)	6.1.3								2			
Insulation Resistance	6.1.4					2,7						
Dielectric Withstanding Voltage	6.1.5					3,6						
Vibration	6.2.1 1	9										
Mechanical Shock	6.2.1 2	11										
Durability	6.2.1 0	4	5		3,9							
Mating/Unmating Force	6.2.2	3,5										
Contact Retention to Housing	6.2.1										3	

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Press Peg	6.2.6								2		
Insertion/Retention Force											
Resistance to Solder Heat	6.3.8							2			
Solderability	6.3.7							3			
Thermal Shock	6.3.1		3			4					
Humidity	6.3.2		9			5					
High Temperature Life	6.3.3			3						2	
MFG (10 Days Unmated)	6.3.4				5						
MFG (10 Days Mated)	6.3.4				7						
Salt Spray	6.3.8						3				
Dust Contamination	6.3.6	7	7								

8.0 RECORD RETENTION

REVISON RECORD

REV	PAGES	DESCRIPTION	EC #	DATE
А	ALL	New release according to GS-12-002 updated	DG07-0105	07/04/02
В	ALL	Update form format	DG09-0065	03/03/09
С	ALL	Update form format for Amphenol FCI	ELX-N-26297	03/08/16